

### **FEATURES**

- Wide supply voltage range 6V ~ 18V
- Input range 500mV beyond the rails
- · Unity-gain stable
- · Rail-to-rail output swing
- High slew rate 40V/µs
- GBWP 20MHz
- 30MHz -3dB Bandwidth
- Ultra-small Package SOT-25 \ TSOT25 \ SOT-26 \ TSOT-26 and TSSOP-8

### **APPLICATIONS**

- TFT-LCD Reference Driver
- Touch-Screen Display
- Wireless LANs
- Personal Communication Devices
- Direct Access Arrangement
- Personal Digital Assistant (PDA)
- Active Filter
- Sampling ADC Amplifier
- ADC/DAC Buffer
- Electronic Notebook
- Office Automation
- Portable Electronics

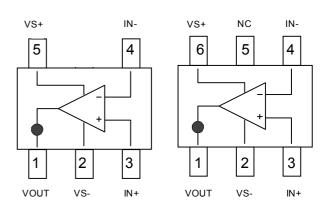
### GENERAL DESCRIPTION

The EC5601 is a rail-to-rail one channel operational amplifier with wide supply range

from 6V to 18V. It provides 0.5V beyond the supply rails of common mode input range and capability of rail-to-rail output swing as well. This enables the amplifier to offer maximum dynamic range at any supply voltage among many applications. A 20MHz gain bandwidth product allows EC5601 to perform more stable than other devices in Internet applications.

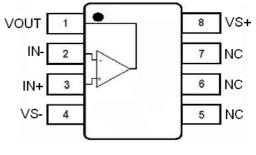
With features of 40V/µs high slew rate and 200ns of fast settling time, as well as 100mA (sink and source) of high output driving capability, the EC5601 is ideal for the requirements of flat panel Thin Film Transistor Liquid Crystal Displays (TFT-LCD) panel grayscale reference buffers application. Due to insensitive to power supply variation, EC5601 offers flexibility of use in multitude of applications such as battery power, portable devices and anywhere low power consumption concerned. With standard operational amplifier pin assignment, the EC5601 is offered in a space saving 6-Pin SOT-26 package and specified over the -40°C to +85°C temperature range.

#### PIN ASSIGNMENT



SOT25/TSOT25

SOT26/TSOT26



TSSOP-8



Functional Pin Description

Pin Name	Pin Function	
VOUT	Operational Amplifier Output	
VS-	IC GROUND or Negative power supply	
IN+	Operational Amplifier Non-Inverting Input	
IN-	Operational Amplifier Inverting Input	
VS+	Supply Voltage VCC can range from 6V to 18V	

### ABSOLUTE MAXIMUM RATINGS (TA = $25 \, ^{\circ}C$ )

Values beyond absolute maximum ratings may cause permanent damage to the device. These are stress ratings only; functional device operation is not implied. Exposure to AMR conditions for extended periods may affect device reliability.

Supply Voltage between VS+ and VS- +18V Storage Temperature -65°C to +150°C Input Voltage VS- -0.5V, VS+ +0.5V Maximum Die Temperature +125°C

Maximum Continuous Output Current 100mA Operating Temperature -40°C to +85°C

Lead Temperature 260°C

**Important Note:** 

All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore: TJ = TC = TA

### **ELECTRICAL CHARACTERISTICS**

 $V_{S+}$ = +5V,  $V_{S-}$  = -5V,  $R_L$  = 10k $\Omega$  and  $C_L$  = 10pF to 0V,  $T_A$  = 25°C unless otherwise specified.

Parameter	Description	Cond	lition	Min	Тур	Max	Units	
Input Cha	Input Characteristics							
Vos	Input Offset Voltage	V <sub>CM</sub> = 0V			2	12	mV	
TCVos	Average Offset Voltage	[1]			5		μV/°C	
I <sub>B</sub>	Input Bias Current	$V_{CM} = 0V$			2	50	nA	
R <sub>IN</sub>	Input Impedance				1		GΩ	
C <sub>IN</sub>	Input Capacitance				1.35		pF	
CMIR	Common-Mode Input			-5.0		+5.5	V	
CMRR	Common-Mode Rejection Ratio	for VIN from -5.5V to 5.5V		50	70		dB	
A <sub>VOL</sub>	Open-Loop Gain	0.5V ≦VOUT ≤ 4.5\	/	75	90		dB	
Output Char	racteristics							
	Output Swing Low-	VS+=8V,VS-=-8V,IL=-5mA			-7.92	- 7.85	V	
V <sub>OH</sub>	Output Swing High	VS+=8V,VS-=-8V,IL	.=5mA	7.85	7.92		V	
I <sub>SC</sub>	Short Circuit Current	(Note 1)			±350		mA	
I <sub>OUT</sub>	Output Current				±100		mΑ	
1 .	l Command	VS+=14V, VS-=0V	Source Current: I load Vout to GND		450		A	
<b>I</b> peak	I <sub>peak</sub> Current	(Note 2)	Sink Current: I load Vout to VDD		450		mA	
Power Supply Performance								
	Power Supply Rejection Ratio	VS is moved from ±2.25V to ±7.75V		60	80		dB	
I <sub>S</sub>	Supply Current	No Load			3		mA	



### **ELECTRICAL CHARACTERISTICS**

 $V_{S+}$ = +5V,  $V_{S-}$  = -5V,  $R_L$  = 10k $\Omega$  and  $C_L$  = 10pF to 0V,  $T_A$  = 25°C unless otherwise specified.

Parameter	Description	Condition	Min	Тур	Max	Units		
Dynamic P	Dynamic Performance							
SR	Slew Rate [2]	VS+=8V,VS-=-8V, -4.0V≦VOUT≨4.0V, 20% to 80%	30	40		V/µs		
t <sub>S</sub>	Settling to +0.1% (AV = +1)	$(AV = +1), V_O = 2V Step$		500		Ns		
BW	-3dB Bandwidth	$R_L = 10k\Omega$ , $C_L = 10pF$		30		MHz		
GBWP	Gain-Bandwidth Product	$R_L = 10k\Omega$ , $CL=10pF$		20		MHz		
PM	Phase Margin	$R_L = 10k\Omega$ , $CL = 10 pF$		50		Degree		
CS	Channel Separation	f = 1 MHz		75		dB		
Temperature Performance								
Temp	Thermal Shutdown			150		$^{\circ}\mathbb{C}$		
Measured over operating temperature range								

- 2. Slew rate is measured on rising and falling edges
- Note 1: Short circuit current is tested with one output at a time.
- Note 2: Ipeak current is for a 1µs pulsed current only, not to exceed thermal characteristics of package.

### TYPICAL PERFORMANCE CURVES

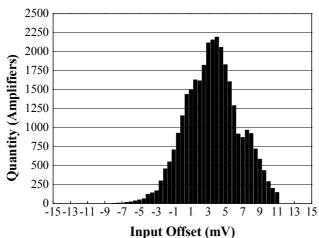
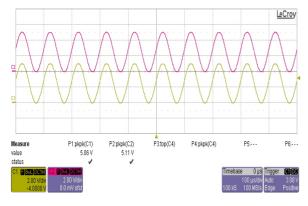


Figure (a) Input Offset Voltage Distribution



Measure P1:pkpk(C1) P2:pkpk(C2) P3:top(C4) P4:pkpk(C4) P5--- P6--value 6:067 V 5:101 V
status
1.00 v/dwr 1.00 v/dwr 0.0 m/V ofs!

Timebase -29:8 us Timeba

Figure (b) Rail to Rail Capability

Figure (c) Input Beyond the Rails Signal



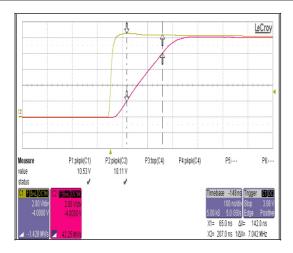


Figure (d) Large Signal Transient Response

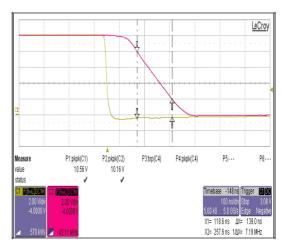


Figure (e) Large Signal Transient Response

### APPLICATIONS INFORMATION

#### **Product Description**

The EC5601 rail-to-rail one channel amplifier is built on an advanced high voltage CMOS process. It's beyond rails input capability and full swing of output range makes itself an ideal amplifier for use in a wide range of general-purpose applications. The features of 40V/µs high slew rate, fast settling time, 30MHz of GBWP as well as high output driving capability have proven the EC5601 a good voltage reference buffer in TFT-LCD for grayscale reference applications. High phase margin and extremely low power consumption make the EC5601 ideal for connected in voltage follower mode for low power high drive applications.

### Supply Voltage, Input Range and Output Swing

The EC5601 can be operated with a single nominal wide supply voltage ranging from 6V to 18V with stable performance over operating temperature of -40°C to +85°C. With 500mV greater than rail-to-rail input common mode voltage range and 70dB of Common Mode Rejection Ratio, the EC5601 allows a wide range sensing among many applications without having any concerns over exceeding the range and no compromise in accuracy. The output swings of the EC5601 typically extend to within 80mV of positive and negative supply rails with load currents of 5mA. The output voltage swing can be even closer to the supply rails by merely decreasing the load current. Figure 1 shows the input and output waveforms for the device in the unity-gain configuration. The amplifier is operated under  $\pm 5V$  supply with a  $10K\Omega$ load connected to GND. The input is a 10Vp-p sinusoid. An Approximately 9.985 Vp-p of output voltage swing can be easily achieved.

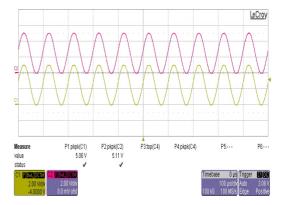


Figure 1. Operation with Rail-to-Rail Input and Output

#### **Output Short Circuit Current Limit**

A +/-350mA short circuit current will be limited by the EC5601 if the output is directly shorted to the positive or the negative supply. For an indefinitely output short circuit, the power dissipation could easily increase such that the device may be damaged. The internal metal interconnections are well designed to prevent the output continuous current from exceeding +/-100mA such that the maximum reliability can be well maintained.

### **Output Phase Reversal**

The EC5601 is designed to prevent its output from being phase reversal as long as the input voltage is limited from VS- -0.5V to VS+ +0.5V. Figure 2 shows a photo of the device output with its input voltage driven beyond the supply rails. Although the phase of the device's output will not be reversed, the input's over-voltage should be avoided. An improper input voltage exceeds supply range by more than 0.6V may result in an over stress damage.



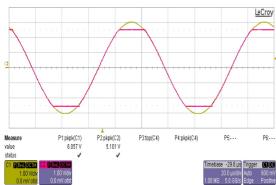


Figure 2. Operation with Beyond-the Rails Input

### **Power Dissipation**

The EC5601 is designed for maximum output current capability. Even though momentary output shorted to ground causes little damage to device.

For the high drive amplifier EC5601, it is possible to exceed the 'absolute-maximum junction temperature' under certain load current conditions. Therefore, it is important to calculate the maximum junction temperature for the application to determine if load conditions need to be modified for the amplifier to remain in the safe operating area. The maximum power dissipation allowed in a package is determined according to:

$$\mathbf{P_{Dmax}} = \frac{T_{Jmax} - T_{Amax}}{\Theta_{JA}}$$

Where:

T<sub>Jmax</sub> = Maximum Junction Temperature

T<sub>Amax</sub>= Maximum Ambient Temperature

 $\Theta_{JA}$  = Thermal Resistance of the Package

**P**<sub>Dmax</sub> = Maximum Power Dissipation in the Package.

The maximum power dissipation actually produced by an IC is the total quiescent supply current times the total power supply voltage, plus the power in the IC due to the loads, or:

 $P_{Dmax} = \sum_{i} [VS * I_{Smax} + (VS + - VO) * I_{L}]$ 

When sourcing, and

 $P_{Dmax} = \sum_{i} [VS * I_{Smax} + (VO - VS -) * I_{L}]$ 

When sinking.

Where:

**i** = 1 to 1

VS = Total Supply Voltage

I<sub>Smax</sub> = Maximum Supply Current Per Amplifier

**VO** = Maximum Output Voltage of the Application

I<sub>L</sub>= Load current

 $R_L$ = Load Resistance = (VS+ - VO)/ $I_L$  = (VO - VS-)/  $I_L$ 

A calculation for  $R_L$  to prevent device from overheat can be easily solved by setting the two  $P_{Dmax}$  equations equal to each other.

#### **Driving Capacitive Loads**

The EC5601 is designed to drive a wide range of capacitive loads. In addition, the output current handling capability of the device allows for good slewing characteristics even with large capacitive loads. The combination of these features make the EC5601 ideally for applications such as TFT LCD panel grayscale reference voltage buffers, ADC input amplifiers, etc.

As load capacitance increases, however, the -3dB bandwidth of the device will decrease and the peaking increase. Depending on the application, it must be necessary to reduce peaking and to improve device stability. To improve device stability, a small value of series resistor (usually between  $5\Omega$  and  $50\Omega$ ) must be placed in series with the output. The advantage is that it improves the settling and overshooting performance with very large capacitive loads. Figure 3. shows the typical application configuration.

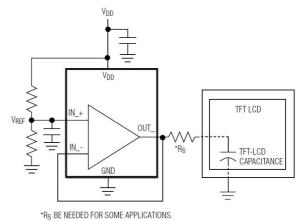


Figure 3. Typical Application Configuration.

## Power Supply Bypassing and Printed Circuit Board Layout

With high phase margin, the EC5601 performs stable gain at high frequency. Like any highfrequency device, good layout of the printed circuit board usually comes with optimum performance. Ground plane construction is highly recommended, lead lengths should be as short as possible and the power supply pins must be well bypassed to reduce the risk of oscillation. For normal single supply operation, where the V<sub>S</sub>- pin is connected to ground, a 0.1 µF ceramic capacitor should be placed from  $V_{S+}$  pin to  $V_{S-}$  pin as a bypassing capacitor. A 4.7 $\mu F$ tantalum capacitor should then be connected in parallel, placed in the region of the amplifier. One 4.7μF capacitor may be used for multiple devices. This same capacitor combination should be placed at each supply pin to ground if split supplies are to be used.

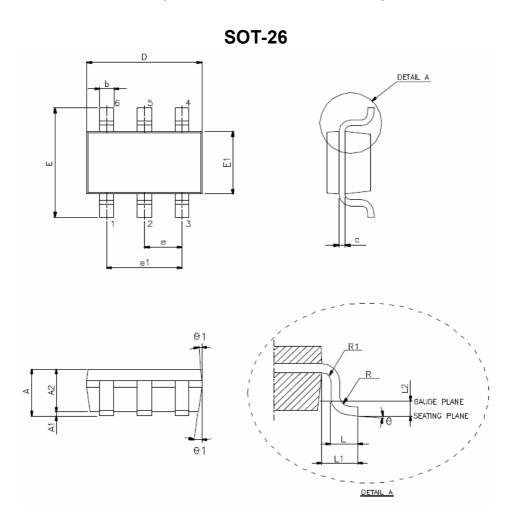


### **ORDERING INFORMATION**

PART NO	TOP MARK	PACKAGE TYPE
EC5601B2-G	EC5601 XXXXX	SOT-25 GREEN PACKAGE "XXXX" is lot code
EC5601T2-G	EC5601 XXXXX	TSOT-25 GREEN PACKAGE "XXXX" is lot code
EC5601B3-G	EC5601 XXXXX	SOT-26 GREEN PACKAGE "XXXX" is lot code
EC5601T3-G	EC5601 XXXXX	TSOT-26 GREEN PACKAGE "XXXX" is lot code
EC5601I-G	EC5601 XXXXX YYWW	TSSOP-8 GREEN PACKAGE "XXXX" is lot code "YYWW" is date code



## **OUTLINE DIMENSIONS** (Dimensions shown in millimeters)

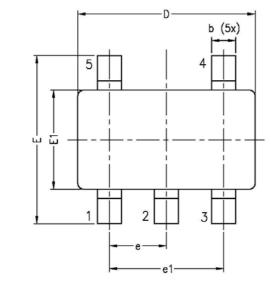


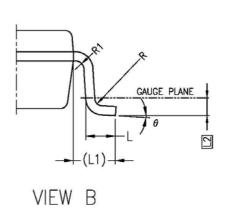
VARIATION(ALL DIMENSIONS SHOWN IN MM)

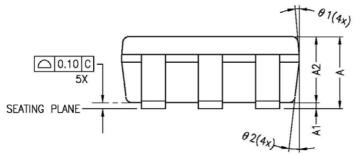
SYMBOL	MIN.	NOM.	MAX.			
Α	-	_	1.45			
A1	1	_	0.15			
A2	0.90	1.15	1.30			
Ь	0.30	_	0.50			
С	0.08	_	0.22			
D		2.90 BSC.				
E	2.80 BSC.					
E1	1.60 BSC.					
е	0.95 BSC					
e1		1.90 BSC.				
L	0.30	0.45	0.60			
L1	0.60 REF.					
L2	0.25 BSC.					
R	010 -		_			
R1	0 10 -		0.25			
0	0.	4.	8,			
⊕1	5*	10°	15'			

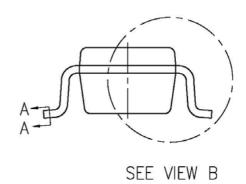


### **SOT-25**







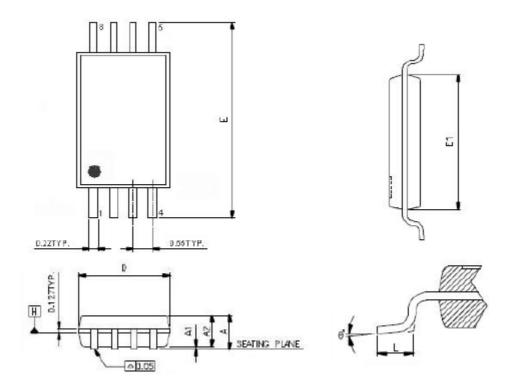


VARIATION(ALL DIMENSIONS SHOWN IN MM)

,			
SYMBOL	MIN.	NOM.	MAX.
Α	ı	_	1.45
A1	1	-	0.15
A2	0.90	1.15	1.30
b	0.30	_	0.50
С	80.0	_	0.22
D		2.90 BSC.	
E	2.80 BSC.		
E1	1.60 BSC.		
е	0.95 BSC		
e1		1.90 BSC.	
L	0.30	0.45	0.60
L1		0.60 REF.	
L2	0.25 BSC.		
R	0 10		
R1	0 10	_	0.25
0	0	4	8,
01	5*	10°	15'



TSSOP-8

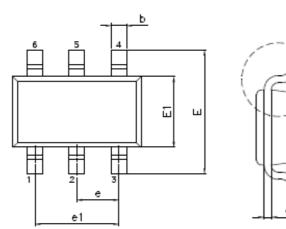


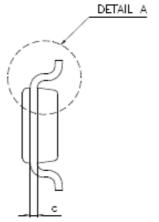
SYMBOLS	MIN.	NOM.	MAX.
А	322	1000	1.20
A1	0.05		0.15
A2	0.96	1.01	1.06
D	2.90	3.00	3.10
E		6.40 BSC	
E1	4.30	4.40	4.50
Ē	0.45	0.60	0.75
θ.	0	-	8

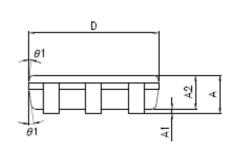
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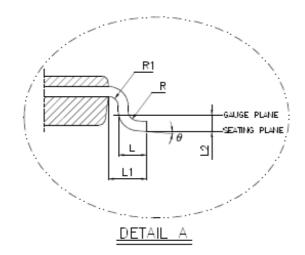


**TSOT-26** 









### VARIATION(ALL DIMENSIONS SHOWN IN MM)

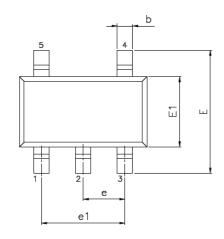
SYMBOL	MIN.	NOM.	MAX.
A	0.750	_	0.800
A1	0.000	_	0.050
A2	0.700	0.750	0.775
Ь	0.350	_	0.500
С	0.100	_	0.200
D	2.800	2.900	3.000
E	2.600	2.800	3.000
E1	1.500	1.600	1.700
е		0.950 BSC	
e1		1.900 BSC	
L	0.370 0.450		0.600
L1		0,600 REF	
L2		0.250 BSC	
R	0.100	_	_
R1	0.100	_	0.250
θ	÷	4"	8
θ1	4"	10"	12"

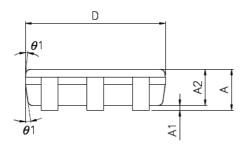
NOTE:

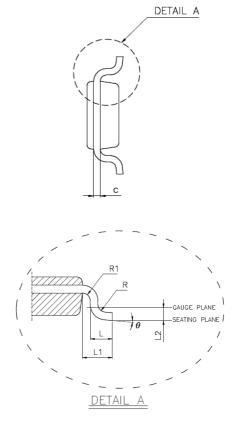
1. JEDEC OUTLINE : N/A.



**TSOT-25** 







### **VARIATION (ALL DIMENSIONS SHOWN IN MM)**

SYMBOL	MIN.	NOM.	MAX.
Α	0.750	-	0.800
A1	0.000	-	0.050
A2	0.700	0.750	0.775
b	0.350	-	0.500
С	0.100	-	0.200
D	2.800	2.900	3.000
E	2.600	2.800	3.000
E1	1.500	1.600	1.700
е		0.950 BSC	
e1		1.900 BSC	
L	0.370	0.450	0.600
L1		0.600 REF	
L2	0.250 BSC		
R	0.100	-	-
R1	0.100	-	0.250
θ	0°	4°	8°
θ1	4°	10°	12°

NOTE:

1. JEDEC OUT LINE: N/A